



# FGM

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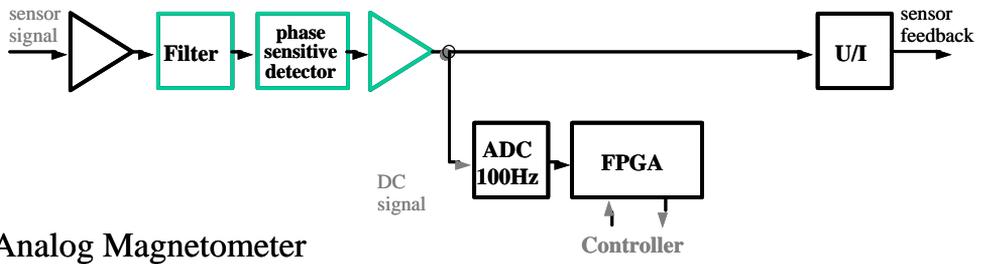
TU Braunschweig



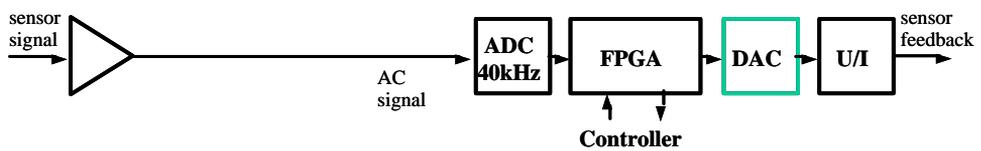
## *FGM*



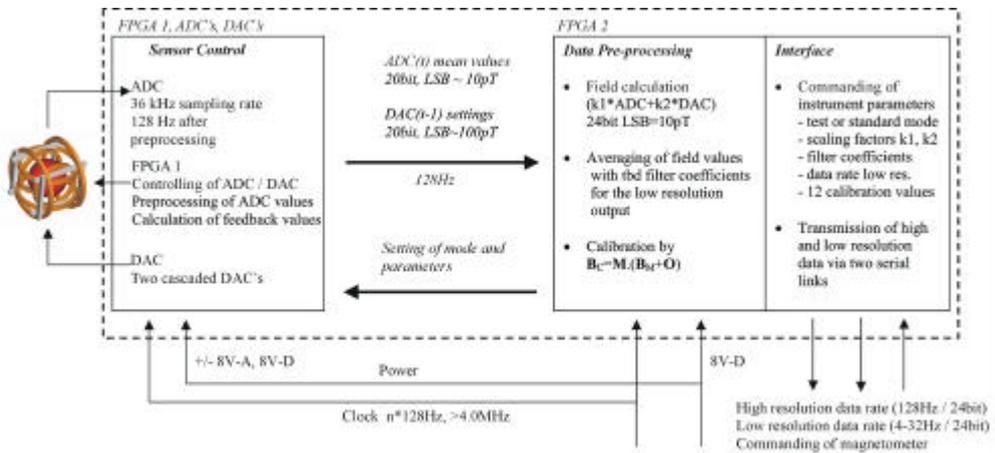
- Overview
  - specifics / subunits / responsibilities / models
- Status Hardware
  - FGS, FGE, FPGA
- Operation
  - Modes and filter characteristics
- Parameter / Expected Accuracy
  - parameter / test results (Venus Express)
- Integration and test program
  - TCU / GSE / Schedule,



Analog Magnetometer



Digital Magnetometer





## *FGM Subunits*



- Fluxgate Sensor (FGS)
  - Hardware: TU-BS
  - Calibration: TU-BS & IWF
- Fluxgate Electronics (FGE)
  - Hardware: TU-BS (subcontracted to Magson) / UCB
  - FPGA design: IWF & Magson
- “Accessories”
  - Boom: UCB
  - GSE: UCB
  - TCU: UCB / IWF / TU-BS (subcontracted to Magson)
  - Magnetic Cleanliness: UCB / UCLA



## *FGM Model Philosophy*

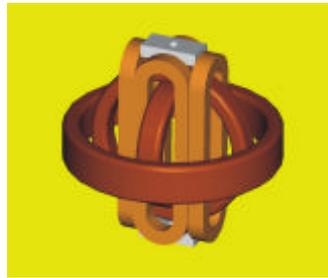


- Fluxgate Sensor (FGS)
  - STM, available in Berkeley for boom test etc.
  - FM 6 qualification & spare model
  - FM 1-5 flight Models
- Fluxgate Electronics (FGE)
  - Breadboard
  - ETU 1, magnetometer only, permanently in Europe
  - ETU 2, merged layout, permanently in Berkeley
  - ETU 3, qualification model / F6
  - FM 1-5
- GSE
  - Available in Berlin
- TCU
  - Up to sensor delivery: 2 TCU's in Europe: 1 at UCB
  - Later: 2 TCU's at UCB: 1 in Europe

## Vector-compensated Ringcore sensor

### Two crossed ringcores

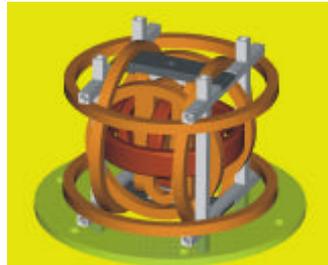
Material: 6-81-Mo Permalloy band  
non-ferromagn. NiMo30 alloy



### Pickup Coil systems

Material: Cu wire isolated by polyesterimid and covered by bond coat (polyamid)

Sensitivity: about 1,5 ... 3µV/nT



### Feedback Coil System

Material: Cu - wire, see pickup

Coil const.: 13-17000nT/mA

CTE: about 24ppm (Cu and Al)

Fixation: by glue (Endfest 300)

## Sensor Hut Interface

Material

Hut & base plate: Aluminium

Isolation: glassfibre reinforced plastics

Screws: titanium

Washers: glassfibre reinforced plastics

Surface (Al): Alodine 1200

Mass: 78g



## Mechanical Interface

mounting: four M4 screws

orientation: defined by ground plane and two feed side planes (V)

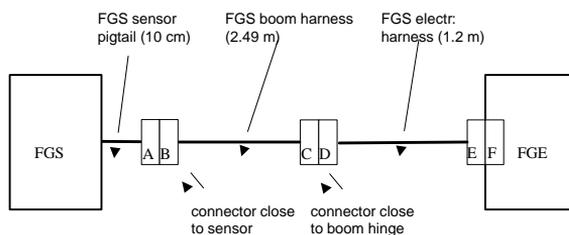
## Electrical Interface

10cm pigtail with HD-26P connector

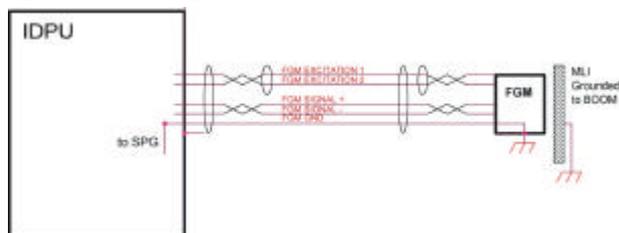


- **Aging:** Extended test program for spare coils added into test matrix. (5 times between -190°C and +120°C)
- **Glue properties:** liquid nitrogen immersion test will be done with GRM sensor (see test matrix)
- **Glue properties:** Tension tests with glued parts
- **Quasi static loads:** Modelling of sensor

- **Harness**
  - A/B connector bracket on the boom
  - C/D connector bracket on the spacecraft



- **Grounding**
  - Overall shielding connected to S/C ground (chassis) via connector back shells
  - Sensor aluminum housing, connected to pin 11 of the sensor connector
  - MLI:
    - inner layer insulating
    - outer layer conductive to boom





## FGS Test Matrix



Test name	Test description	Ringcores Coils only	STM	FM 1-6
Ringcore selection	Long-term test of ringcores (KHF) <i>Criteria: output voltage, offset, noise</i>		X	X
Parts electr. checkout	Resistance of all coils before integration (KHF)		X	X
Coil qualification	-190°C / +120°C five times each (BS) <i>Criteria: visual inspection, resistance</i>	X		
Coil aging acceptance	-40°C / +80°C three times each (BS) <i>Criteria: visual inspection, resistance</i>		X	X
Ringcore checkout	Test after integration in pickup coils (KHF). <i>Criteria: output voltage, offset, noise</i>		X	X
FGS electr. checkout	Test after sensor integration (KHF) <i>Criteria: Resistance + polarity of all coils</i>		X	X
FGS aging qualification	-190°C / +120°C five times each (KHF) <i>Criteria: visual inspection, resistance, output voltage, offset, noise</i>		X	
FGS aging acceptance	-40°C / +80°C three times each (KHF) <i>Criteria: visual inspection, resistance, output voltage, offset, noise</i>			X



## FGS Test Matrix



Test name	Test description	STM	FM 6	FM 1-5
Vibration	According to qualification levels (UA) According to acceptance levels	With Boom	X	X
TV	According to qualification levels (WM) According to acceptance levels	With Boom	X	X
Calibration	Berlin / Braunschweig: <i>Offset, noise at room temperature, versus electronics temperature, versus time</i>			
	Graz: <i>Offset, noise, transfer function versus temp</i>			
	Magnetsrode: <i>Scale value, orthogonality versus temp</i>			

### Required temperature range

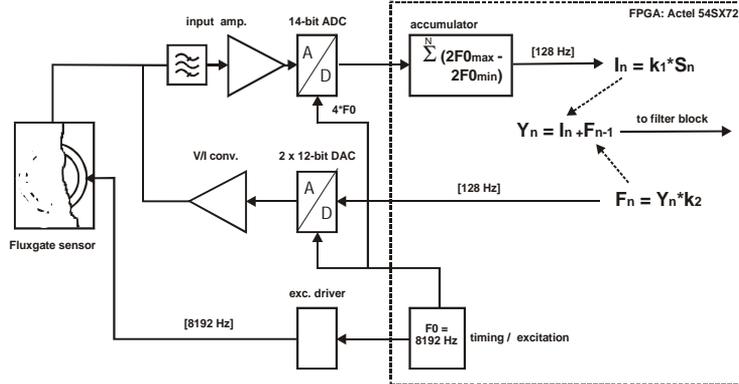
Operation:	-100°C ... +65°C
Survival:	-100°C ... +65°C
Estimation by thermal analysis:	-79°C ... +35°C

## Part of FGE

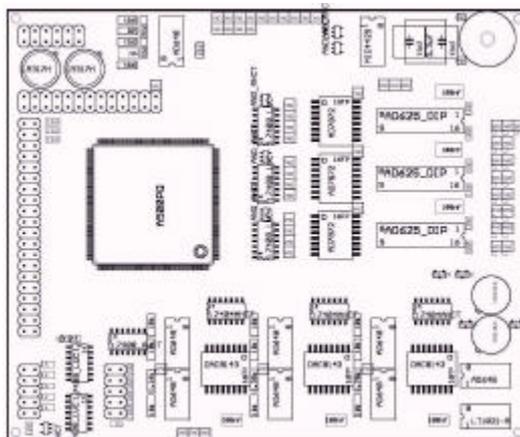
- Excitation
- Preamplifier
- Analog/Digital Converter
- Feedback
- FPGA

## Power Consumption

Excitation	180mW	760mW
Preamplifier	180mW	
Analog/Digital Converter	150mW	
Feedback	200mW	
FPGA	50mW (85mW)	

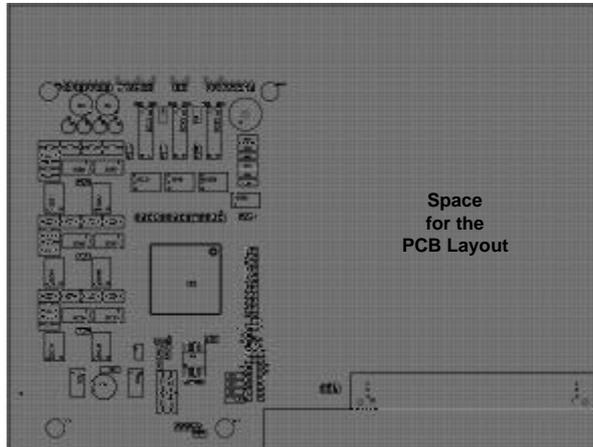


- The Bread Board is used to test the general electronics design and the FPGA design along with a GSE supplied by the IWF Graz



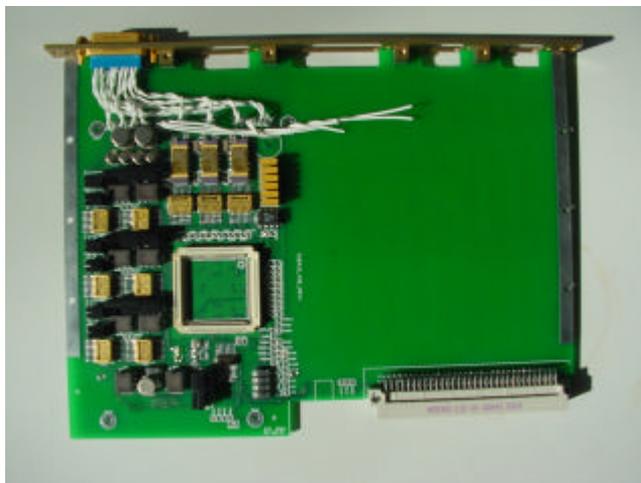
Layout of the Bread Board

- The FGE will co-reside with PCB on a single 6U board.
- The FGE will be placed on the opposite half of J1 connector site.



6U Board with the FGE Layout

- ETU 1 is under test in Berlin, FPGA (non radiation hard) on socket.
- ETU 2/3 layout is merged, fabrication population of ETU 2 in ongoing





## *FGE, Changes since PDR*



- all DAC's are now placed on the top side
- Megatron precision resistors have been replaced by MIL-qualified Vishay types
- WIMA high value capacitors in the excitation circuitry have been replaced by MIL-qualified Kemet types
- FGE internal grounding concept has been improved:
  - separate ground nets for all functional parts,
  - connected at a star point close to the Power interface
  - RC-filter implemented to react on external power disturbances
- ADC analog interface simplified and improved based on experience of Venus Express
- ADC serial interface mode was changed
  - the ADC will now be clocked by the system clock instead of using the ADC's internal clock
  - no need to synchronise ADC clock to the system clock
  - reduces potential interfering frequencies on the board

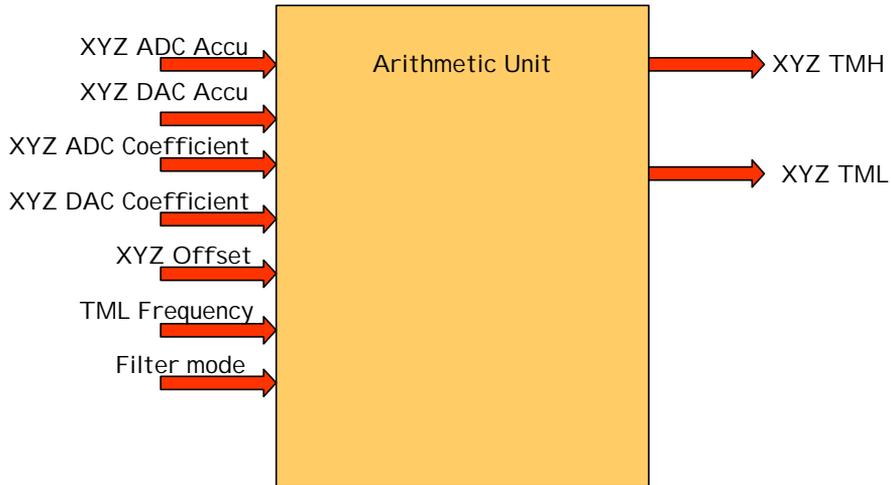


## *FGE, FPGA design*



- The FGE electronics is controlled by a FPGA which overtakes the following tasks:
  - Generating the Excitation Signal
  - Reading the ADC Data
  - Generating the Feedback Values
  - Calculating the Output Data
  - Acting as Command Receiver and Data Transmitter
  - Configuration of FGM
    - data rate TML
    - mode (standard, calibration, feedback on/off, excitation on/off)
    - filter modes
    - ADC and DAC calibration coefficients, offsets

### FPGA Arithmetic Unit



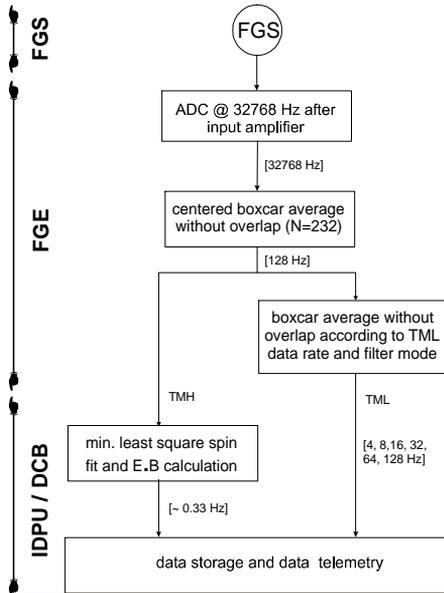
- FGE BB Implementation in ProASIC A500K180 (24%)
- FPGA design completely routed in RT54SX72S (80%)
- Actually under test using ETU1, all functions are working well
- Last and final risk is the compatibility of the design with the RadHard Actel



# FGM Operation



## FGM signal flow



2 x Boxcar filter

amplitude response

$$|G(\omega)| = \frac{\sin(\omega T N / 2)}{N \times \sin(\omega T / 2)}$$

phase response

$$\text{ang}(G(\omega)) = -\omega N f T$$

*N ... number of accumulated samples*

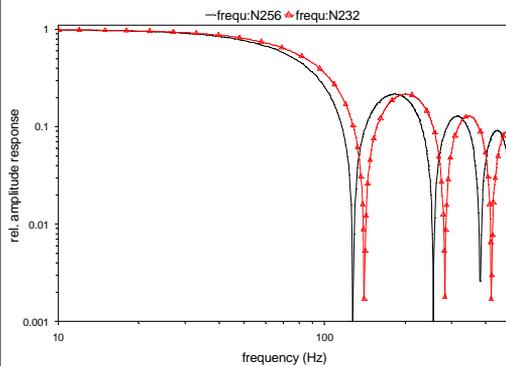
*T ... sampling period (1/(4F0) or 128 Hz)*



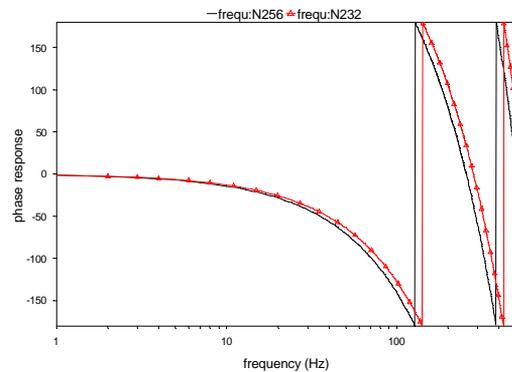
# FGM Operation



## FGM raw data frequency response



amplitude response of the 128 Hz raw data



phase response of the 128 Hz raw data



# FGM Operation



## FGM filter modes

- Filter mode 1:
  - only data decimation (D)
  - 4 Hz data with 5.7 x higher noise
  - huge aliasing
  - no de-spinning problems
- Filter mode 2:
  - filter calc. down to 16 Hz ( $N_f$ )
  - decimation from 16 to 4 Hz
  - 4 Hz data with 2 x higher noise
  - less aliasing
  - little de-spinning problems
- Filter mode 3:
  - filter calc. down to 4 Hz
  - little aliasing
  - de-spinning problems

$$|G(\omega)| = \frac{\sin(\omega T N / 2)}{N \times \sin(\omega T / 2)} \cdot \frac{\sin(\omega T_r N_f / 2)}{N_f \times \sin(\omega T_r / 2)}$$

$$\text{ang}(G(\omega)) = -\omega p f (NT + N_f T_r)$$

$N_f$  ... number of accumulated samples in table  
 $T_r$  ... raw data rate (1/128)

TML data rate [Hz]	filter mode 1		filter mode 2		filter mode 3	
	$N_f$	D	$N_f$	D	$N_f$	D
128	-	-	-	-	-	-
64	-	2	4	2	2	2
32	-	4	8	4	4	4
16	-	8	16	8	8	8
8	-	16	-	2	16	16
4	-	32	-	4	32	32

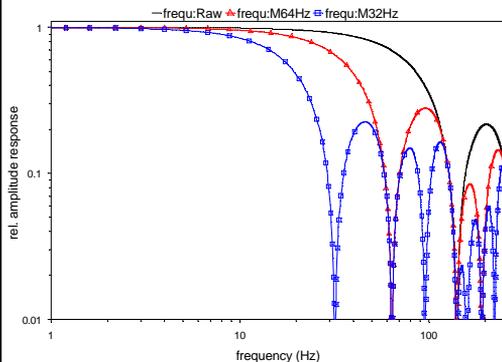
Number of data decimation (D) and accumulation ( $N_f$ ) according to the selected filter mode



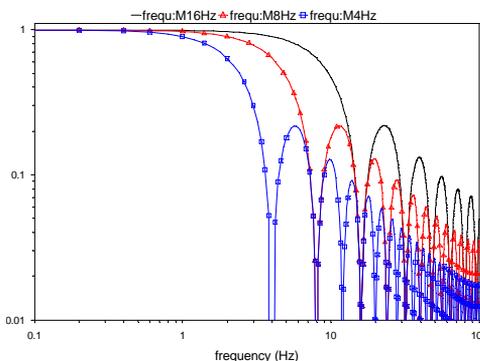
# FGM Operation



## FGM TML data frequency response



Amplitude characteristics of the 128 Hz raw data as well as the 64 Hz and 32 Hz output data (filter mode 2 and 3)



Amplitude characteristics of the 16 (filter mode 2 and 3), 8 and 4 Hz (filter mode 3) output data



## *FGM Operation*



- **FGM operation during all science phases**
  - Slow Survey: 1 vector / spin
  - Fast Survey: 4 vectors / sec
  - Particle Burst: 32 vectors / sec
  - Wave Burst 1/2: 128 vectors / sec
- **FGM operation during boom deployment**
  - Check of the magnetic moment of the S/C
- **FGM operation during complete checkout phase**
  - Survey of DC and AC magnetic disturbances



## *FGM Operation*



- **FGM operation during special mission phases**
  - Change of orbit
  - Eclipse
- **Special use of FGM data**
  - S/C attitude control in perigee
  - Knowledge of FGS axes to spin axis orientation
  - During perigee knowledge of FGS axes relative to a geophysical reference system with 0.1 degree accuracy (request for a 56 nT accuracy in course feedback range)



## FGM default turn on

- At least Start command from Data Control Board
- Default values for phase, sampling, K-values, offsets and averaging mode stored in FPGA
- Start of data acquisition with one second sync
- Field calculation:  $k1*ADC+k2*DAC+Offset$  (@ 128 Hz)
- 24 bits per axis (LSB ~ 3 pT - 25,000 nT range)
- TML output: 4 Hz data in filter mode 2

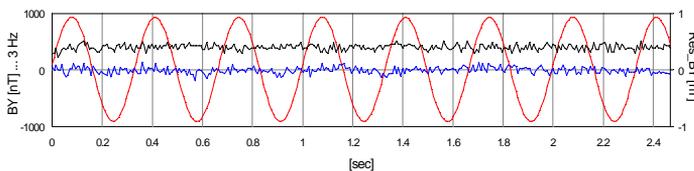
## IDPU tasks

- Auto ranging by taking only 16 bits per axis
- Calculation of spin-average data (Slow Survey Modes)

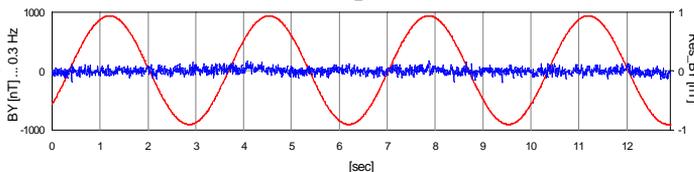


## Large field feedback (VEX-MAG)

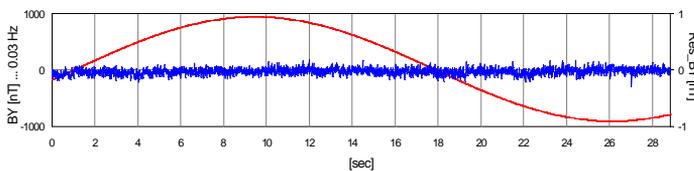
±900 nT; 3 Hz; 128 Hz FB update  
 max. FB step of 130 nT;  
 STD residuum: 54 pT  
 STD noise: 48 pT (0.5 .. 64 Hz)



±900 nT; 0.3 Hz; 128 Hz FB update  
 max. FB step of 13 nT;  
 STD residuum: 53 pT (0.1 .. 64 Hz)



±900 nT; 0.03 Hz; 128 Hz FB update;  
 max. FB step of 1.3 nT;  
 STD residuum: 56 pT (0.04 .. 64 Hz)

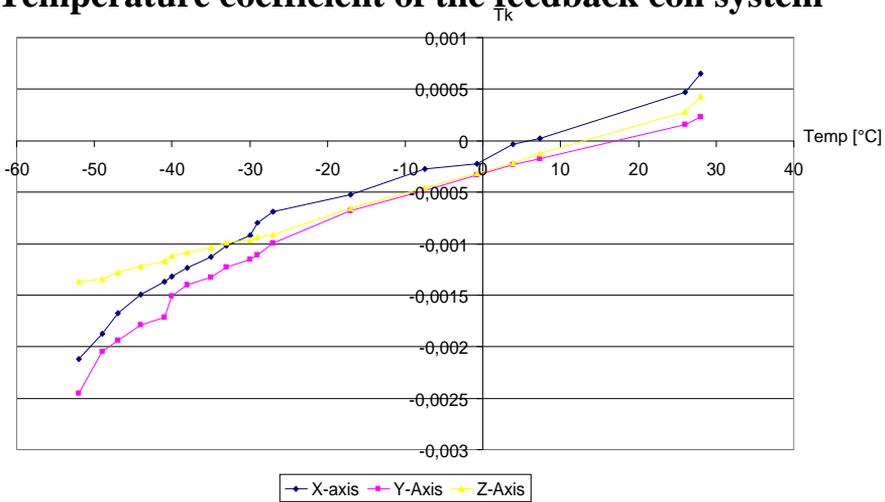




# FGM parameter



## Temperature coefficient of the feedback coil system



CTE-X: 2,7007E-05

CTE-Y: 2,60801E-05

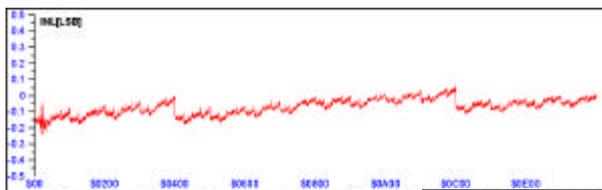
CTE-Z: 2,21543E-05



# FGM parameter

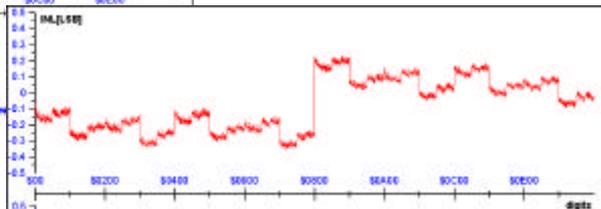


## DAC differential and integral non-linearity



DACTST\_T25

A good ...



DACTST\_T29

... and a bad one.



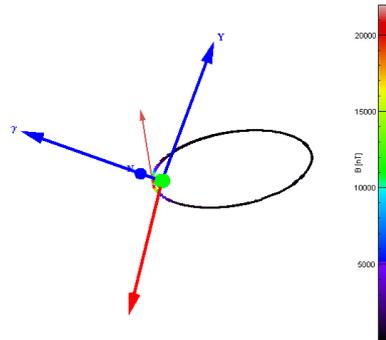
## FGM parameter



### P2: Expected field magnitude

Per Apo Inc Aper Raan a e  
 1,2 20 7 15 315 10,6 0,89

B max = 21950nT



	P1	P2	P3,4	P5
B max [nT]	10480	21950	6450	14330
< 125 nT [%]	94.8	90.3	77.0	77.0
> 125 nT [%]	1.2	2.4	6.4	4.6
> 250 nT [%]	0.9	1.7	3.9	5.4
> 500 nT [%]	0.7	1.3	3.3	4.0
> 1000 nT [%]	2.4	4.3	9.4	9.0



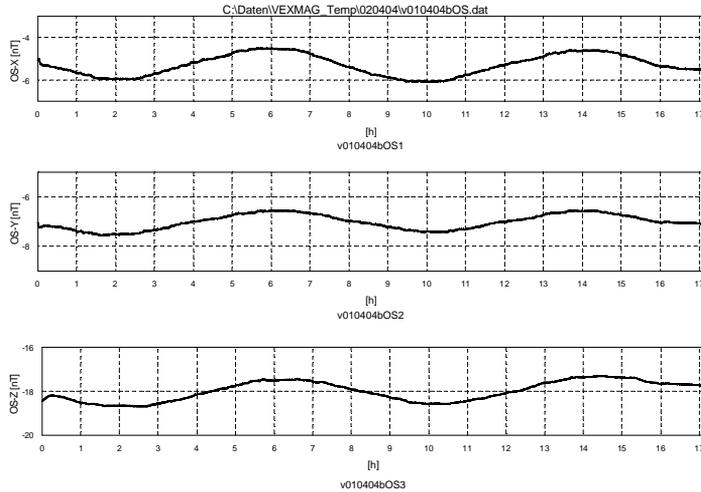
## FGM parameter



### ■ Consequences of DAC non-linearity and orbit simulation on measurement accuracy

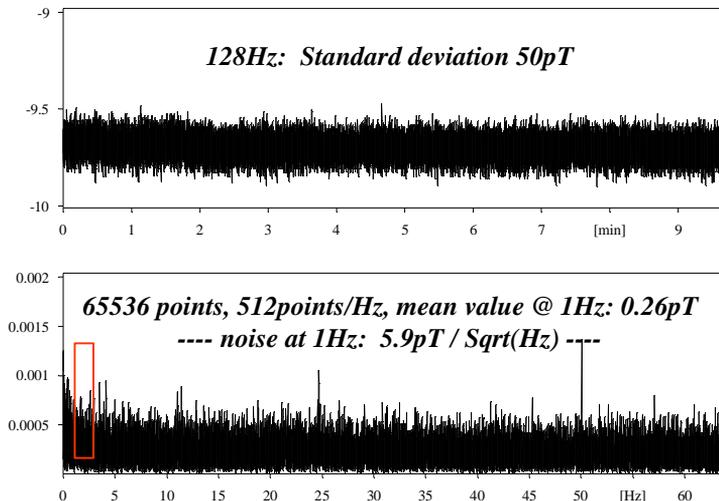
- Dynamic range reduced from  $\pm 32.768$  nT to  $\pm 25.000$  nT
- Digital resolution of approx. 3 pT (24 bits)
- Fine (12 bits) and course (6 bits) feedback DAC
- Dynamic range of fine DAC is  $\pm 390$  nT with 0.19 nT resolution
- Maximum error due to DNL in fine (,science') range of 44 pT
- Dynamic range of course DAC is  $\pm 32,768$  nT with 1024 nT resolution
- Maximum error due to DNL in course range of 6 nT

## Venus Express test results



- The absolute stability of the FGM shall be less than 1nT
- The relative stability of the FGM shall be less than 0.2nT/12hrs

## Venus Express test results



- The FGM noise level @ 1Hz shall be less than 0.03nT/sqrt(Hz)



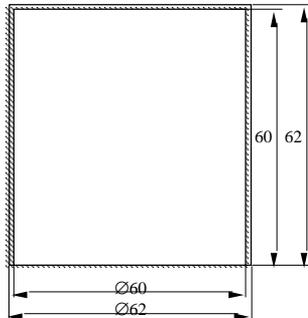
- The FGM science range shall exceed 0-1000nT
  - Max. range 25.000nT
  - Limitation in upper ranges by DLN
  
- The FGM digital resolution shall be less than 0.1nT
  - 25.000nT / 23bit = 3.0pT (transmission to IDPU)
  - Selection of significant 16bit (by IDPU)
    - 3.0pT if  $B < 100\text{nT}$
    - 6.0pT if  $B < 200\text{nT}$
    - .....
    - 0.8nT if  $B > 12500\text{nT}$



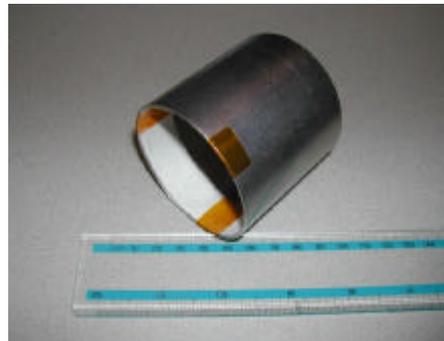
### FGM Sensor configuration during S/C I&T

- **Level 0 - without sensor**
  - B-field about zero if FGM in Cal Mode (preferred mode)
  - B-field saturated if feedback is closed
  - Interface full functional
  - Power consumption reduced by 200mW
  
- **Level 1- Sensor in Mu-metal cup**
  - B-field about 10.000nT, Noise about 1nT
  - Full functionality, but B-field value not representative
  
- **Level 2 - Sensor in TCU with extended harness**
  - B-field  $< 10\text{nT}$ , Noise  $< 10\text{pT}/\sqrt{\text{Hz}}$
  - B-field has to be available in full quality
  - Delta in calibration coefficients known

## Level 1: Mu Metal Can



Shielding factor of 10-50



FGM MGSE which can be put over the sensor

## Themis Calibration Unit



- Consists of
  - Three layer mu-metal can
  - Three axis coil system
  - Mechanics incl. sensor rotation opportunity
- Future locations
  - Braunschweig (Berlin)
  - Graz
  - Berkeley (Swales)



### Purpose of TCU

- Noise & interference determination
  - Noise < 10pT/Sqrt(Hz)
  - Disturbances > 50pT
- Offset determination
  - By sensor rotation in X-Y direction with 0.1nT accuracy
- Scale value determination
  - In Z direction with 0.1% accuracy
- Transfer function determination
  - Up to 1kHz
- Sensor stimulation
  - In all three axes, e.g. Earth orbits, satellite rotation



### Schedule

- Basic Functions as well as all magnetometer relevant parameters are tested with Venus Express Magnetometer
  - Identical sensor
  - 90% identical electronics (all active parts)
- FGE Interface and functionality is tested with BB & ETU1
  - Available at Magson
- FPGA permanently under development
- FGS in time
- ETU's status deviates from original plan
- FGE FM's: no showstoppers visible